

# N-Ch Small Signal Trench MOSFET 2N7002KB

This Small Signal Trench MOSFET has low on resistance, low gate charge and ESD Protected characteristics. It is mainly suitable for Battery Operated Systems and Direct logic-level Interface applications.

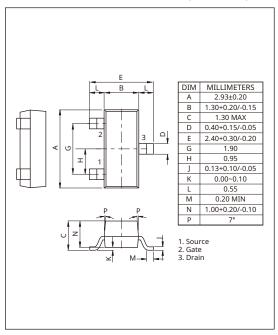
### **FEATURES**

- $V_{DSS}$ =60V,  $I_{D}$ =0.3A
- Drain-Source ON Resistance :

 $R_{DS(ON)}(Max) = 2.2\Omega @V_{GS} = 10V$ 

• ESD Protected: 2KV

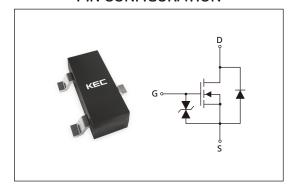
### PACKAGE DIMENSION(SOT-23)



## **APPLICATION**

- Battery Operated Systems
- Direct logic-level Interface
- Voltage controlled small signal switch

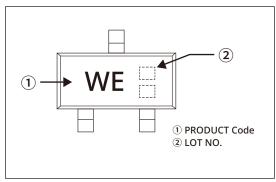
### PIN CONFIGURATION



### ORDERING INFORMATION

PART NUMBER	QTY PER BOX	BOX SIZE
2N7002KB-RTK/HP	9,000pcs	185X185X40mm

### **MARKING CODE**



## MAXIMUM RATING ( $T_J$ =25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT	
Drain-Source Voltage		$V_{\scriptscriptstyle DSS}$	60	V	
Gate-Source Voltage		$V_{\rm GSS}$	±20	V	
Drain Current	@T <sub>A</sub> = 25°C (Note 1, 2)	$I_{_{D}}$	0.3*	A	
	Pulsed (Note 1, 3)	$I_{DP}$	1.0*		
Orain Power Dissipation $@T_A = 25^{\circ}C \text{ (Note 2)}$		$P_{_{D}}$	400	mW	
Maximum Junction Temperature		$T_{_{J}}$	150	°C	
Operation and Storage Temperature Range		T <sub>opr</sub> , T <sub>stg</sub>	-55~150	°C	
Thermal Characteristics					
Thermal Resistance, Junction-to-Ambient @T <sub>A</sub> = 25°C (Note 2)		R <sub>thJA</sub>	310	°C/W	

<sup>\*:</sup> Drain current limited by maximum junction temperature

## ELECTRICAL CHARACTERISTICS (T $_{_{J}}$ = 25 $^{\circ}$ C)

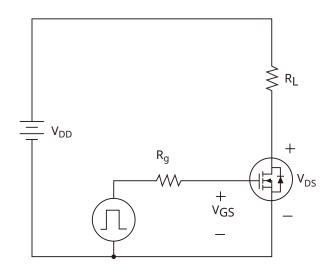
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Static						1
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	60	-	-	V
Drain Cut-off Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V	-	-	10	μΑ
Gate Threshold Voltage	V <sub>th</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1.0	-	2.5	٧
Gate Leakage Current	$I_{GSS}$	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±10	μΑ
Drain-Source ON Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =0.3A	-	1.7	2.2	Ω
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =0.2A	-	2.1	2.9	Ω
Dynamic						1
Turn-on Delay time	t <sub>d(on)</sub>	$V_{DD} = 30V, I_{D} = 0.2A$ $V_{GS} = 10V, R_{G} = 25\Omega$ (Note 3)	-	5	-	ns
Turn-on Rise time	t <sub>r</sub>		-	5	-	
Turn-off Delay time	t <sub>d(off)</sub>		-	40	-	
Turn-off Fall time	t <sub>f</sub>		-	6	-	
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHz	-	15	-	
Output Capacitance	C <sub>oss</sub>		-	3.2	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	1.2	-	
Source-Drain Diode Ratings	•		1			
Continuous Source Current	I <sub>s</sub>	$V_{GS} < V_{th}$	-	-	0.25	Α
Diode Forward Voltage	V <sub>SD</sub>	I <sub>s</sub> =0.25A, V <sub>GS</sub> =0V	-	-	1.2	V

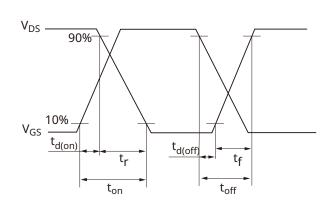
Note 1) Max. current is limited by junction temperature

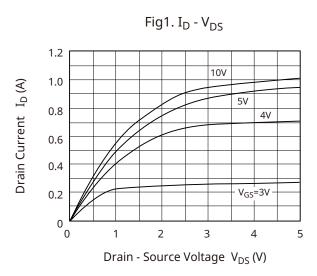
Note 2) Surface mounted on 1 in<sup>2</sup> FR-4 board with 1oz

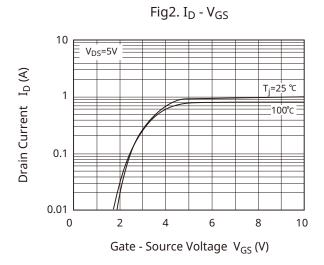
Note 3) Pulse Test (Pulse width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%)

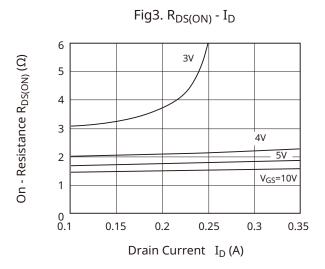
## **SWITCHING TIME TEST CIRCUIT**

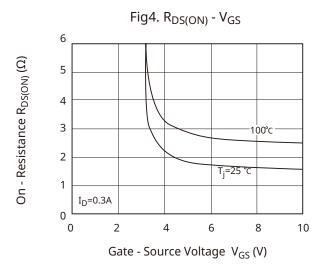


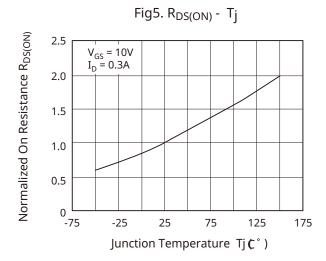


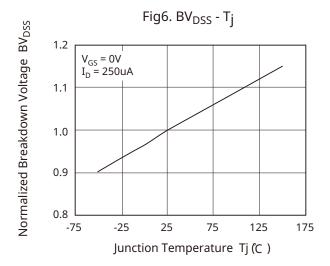


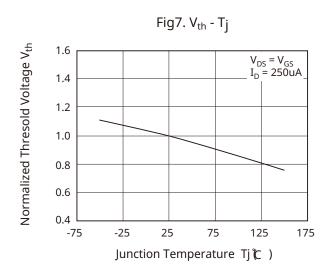


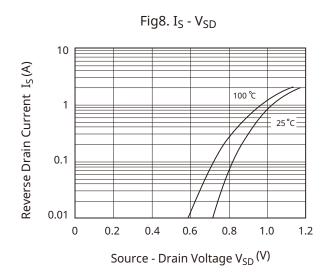


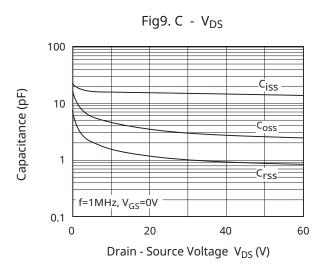


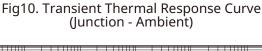


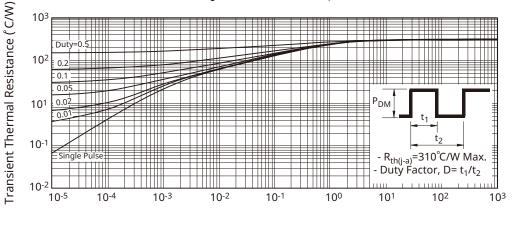




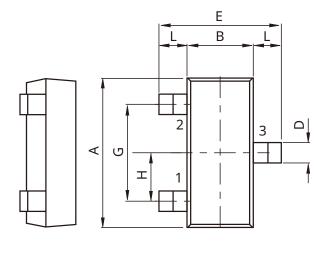


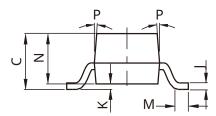






## PACKAGE INFORMATION(SOT-23)



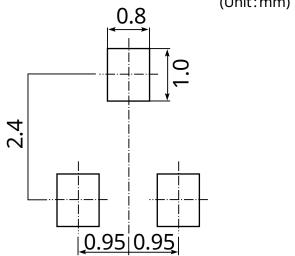


DIM	MILLIMETERS
Α	2.93±0.20
В	1.30+0.20/-0.15
С	1.30 MAX
D	0.40+0.15/-0.05
Е	2.40+0.30/-0.20
G	1.90
Н	0.95
J	0.13+0.10/-0.05
K	0.00~0.10
L	0.55
М	0.20 MIN
N	1.00+0.20/-0.10
Р	7°

- 1. Source 2. Gate

## **RECOMMENDED PAD DIMENSION**

(Unit:mm)



### PRECAUTION ON USING KEC PRODUCTS

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- 2. When you intend to use these products with equipment or device which require an extremely high of reliability and special applications (such as automobile, air travel aerospace, transportation equipment, life support, system and safety devices) in which special quality and reliability and the failure or malfunction of products may directly jeopardize or harm the human body or damage to property and any application other than the standard application intended, please be sure to consult with our sales representative in advance.
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